

## Silicon Diffused Power Transistor

BU2520AW

## GENERAL DESCRIPTION

New generation, high-voltage, high-speed switching npn transistor in a plastic envelope intended for use in horizontal deflection circuits of large screen colour television receivers up to 32 kHz.

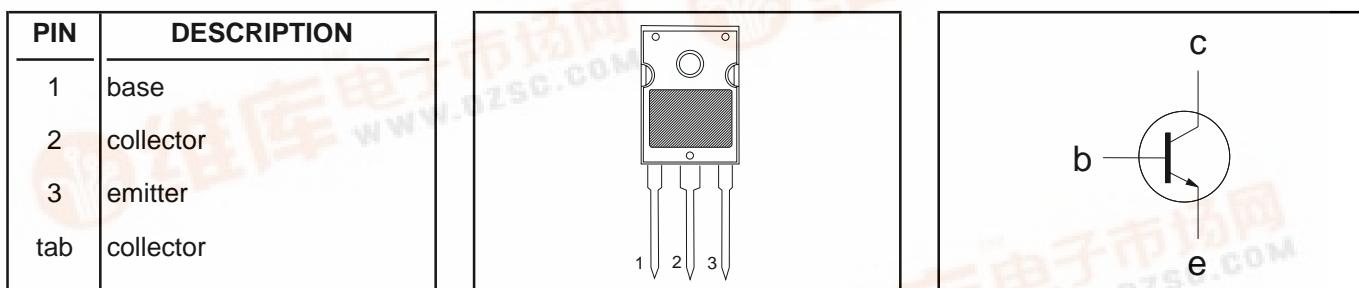
## QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$V_{CESM}$	Collector-emitter voltage peak value	$V_{BE} = 0 \text{ V}$	-	1500	V
$V_{CEO}$	Collector-emitter voltage (open base)		-	800	V
$I_C$	Collector current (DC)		-	10	A
$I_{CM}$	Collector current peak value		-	25	A
$P_{tot}$	Total power dissipation	$T_{mb} \leq 25 \text{ }^\circ\text{C}$	-	125	W
$V_{CEsat}$	Collector-emitter saturation voltage	$I_C = 6.0 \text{ A}; I_B = 1.2 \text{ A}$	-	5.0	V
$I_{Csat}$	Collector saturation current		6	-	A
$t_f$	Fall time	$I_{Csat} = 6.0 \text{ A}; I_{B(end)} = 0.85 \text{ A}$	0.2	0.35	$\mu\text{s}$

## PINNING - SOT429

## PIN CONFIGURATION

## SYMBOL



## LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CESM}$	Collector-emitter voltage peak value	$V_{BE} = 0 \text{ V}$	-	1500	V
$V_{CEO}$	Collector-emitter voltage (open base)		-	800	V
$I_C$	Collector current (DC)		-	10	A
$I_{CM}$	Collector current peak value		-	25	A
$I_B$	Base current (DC)		-	6	A
$I_{BM}$	Base current peak value		-	9	A
$-I_{B(AV)}$	Reverse base current	average over any 20 ms period	-	150	mA
$-I_{BM}$	Reverse base current peak value <sup>1</sup>		-	6	A
$P_{tot}$	Total power dissipation	$T_{mb} \leq 25 \text{ }^\circ\text{C}$	-	125	W
$T_{stg}$	Storage temperature		-65	150	$^\circ\text{C}$
$T_j$	Junction temperature		-	150	$^\circ\text{C}$

## THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th j-mb}$	Junction to mounting base	-	-	1.0	K/W
$R_{th j-a}$	Junction to ambient	in free air	45	-	K/W

<sup>1</sup> Turn-off current.

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**STATIC CHARACTERISTICS** $T_{mb} = 25^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_{CES}$	Collector cut-off current <sup>2</sup>	$V_{BE} = 0 \text{ V}; V_{CE} = V_{CESMmax}$	-	-	1.0	mA
$I_{CES}$		$V_{BE} = 0 \text{ V}; V_{CE} = V_{CESMmax}$	-	-	2.0	mA
$I_{EBO}$	Emitter cut-off current	$T_j = 125^\circ\text{C}$	-	-	1.0	mA
$BV_{EBO}$	Emitter-base breakdown voltage	$V_{EB} = 7.5 \text{ V}; I_c = 0 \text{ A}$	7.5	13.5	-	V
$V_{CEO}sust$	Collector-emitter sustaining voltage	$I_B = 1 \text{ mA}$	800	-	-	V
$V_{CEsat}$	Collector-emitter saturation voltage	$I_B = 0 \text{ A}; I_c = 100 \text{ mA}; L = 25 \mu\text{H}$	-	-	5.0	V
$V_{BESat}$	Base-emitter saturation voltage	$I_c = 6.0 \text{ A}; I_B = 1.2 \text{ A}$	-	-	1.1	V
$h_{FE}$	DC current gain	$I_c = 6.0 \text{ A}; I_B = 1.2 \text{ A}$	-	-	-	V
$h_{FE}$		$I_c = 100 \text{ mA}; V_{CE} = 5 \text{ V}$	-	13	-	V
		$I_c = 6 \text{ A}; V_{CE} = 5 \text{ V}$	5	7	9.5	V

**DYNAMIC CHARACTERISTICS** $T_{mb} = 25^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$C_c$	Collector capacitance	$I_E = 0 \text{ A}; V_{CB} = 10 \text{ V}; f = 1 \text{ MHz}$	115	-	pF
$t_s$	Switching times (32 kHz line deflection circuit)	$I_{Csat} = 6.0 \text{ A}; L_C = 330 \mu\text{H}; C_{fb} = 9 \text{ nF}$			
$t_f$	Turn-off storage time Turn-off fall time	$I_{B(end)} = 0.85 \text{ A}; L_B = 3.45 \mu\text{H}; -V_{BB} = 4 \text{ V}; (-dI_B/dt = 1.2 \text{ A}/\mu\text{s})$	3.0	4.0	$\mu\text{s}$
$t_s$	Switching times (16 kHz line deflection circuit)	$I_{Csat} = 6.0 \text{ A}; L_C = 650 \mu\text{H}; C_{fb} = 19 \text{ nF}$			
$t_f$	Turn-off storage time Turn-off fall time	$I_{B(end)} = 1.0 \text{ A}; L_B = 5.3 \mu\text{H}; -V_{BB} = 4 \text{ V}; (-dI_B/dt = 0.8 \text{ A}/\mu\text{s})$	4.5	5.5	$\mu\text{s}$

<sup>2</sup> Measured with half sine-wave voltage (curve tracer).

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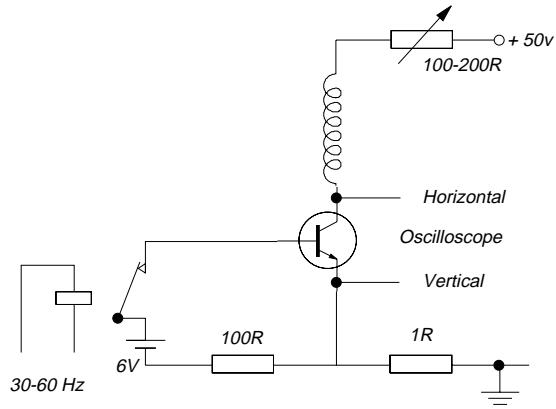
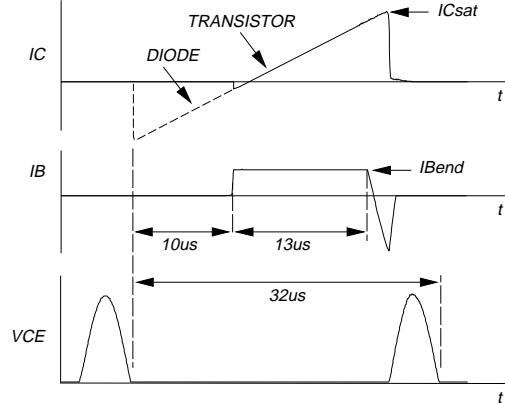
Fig.1. Test circuit for  $V_{CEO}^{sust}$ .

Fig.4. Switching times waveforms (32 kHz).

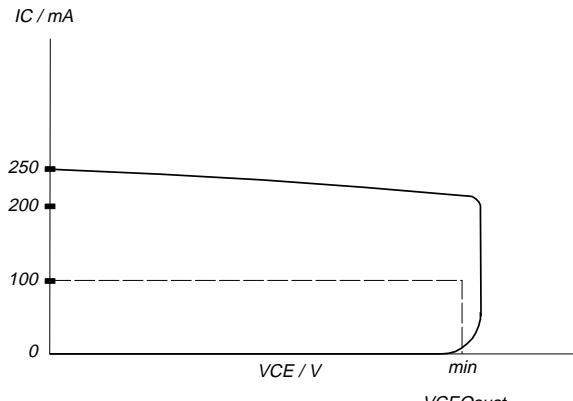
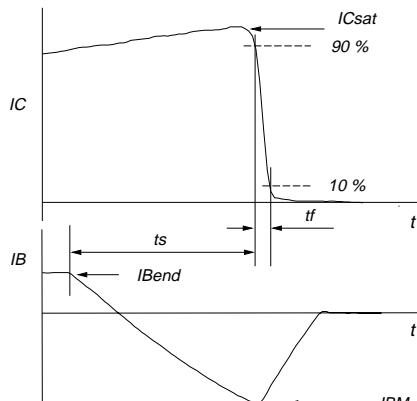
Fig.2. Oscilloscope display for  $V_{CEO}^{sust}$ .

Fig.5. Switching times definitions.

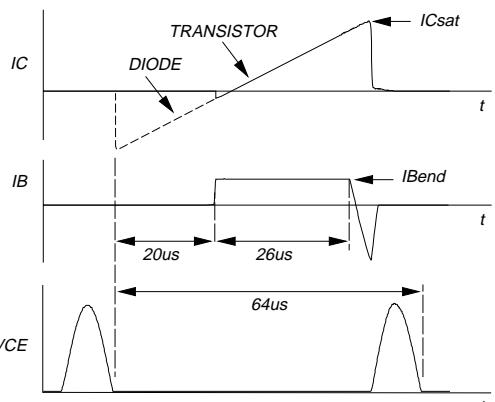


Fig.3. Switching times waveforms (16 kHz).

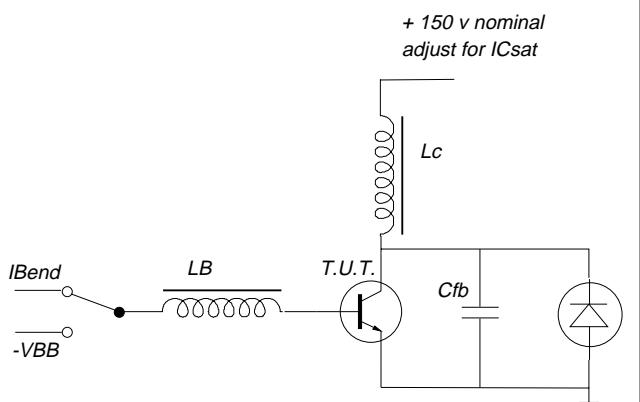


Fig.6. Switching times test circuit (BU2520A).

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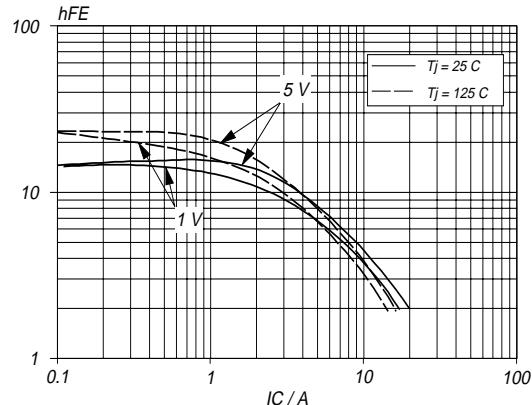


Fig.7. Typical DC current gain.  $h_{FE} = f(I_C)$  parameter  $V_{CE}$

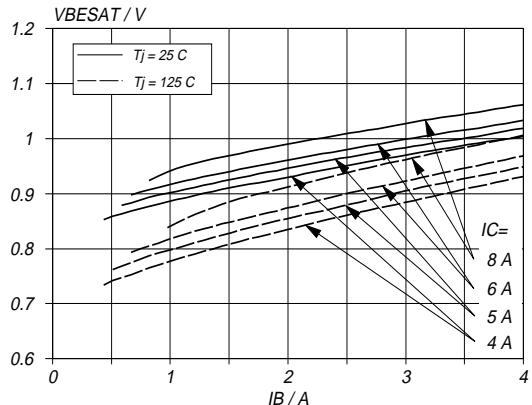


Fig.10. Typical base-emitter saturation voltage.  $V_{BE\text{sat}} = f(I_B)$ ; parameter  $I_C$

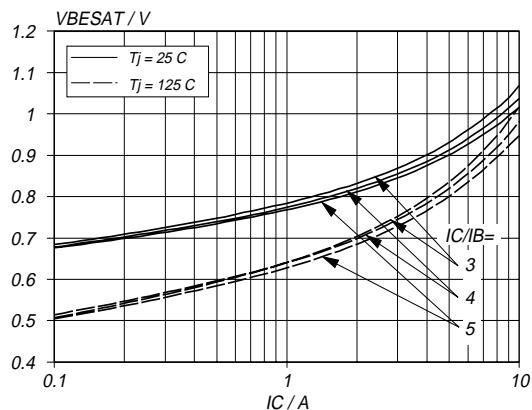


Fig.8. Typical base-emitter saturation voltage.  $V_{BE\text{sat}} = f(I_C)$ ; parameter  $I_C/I_B$

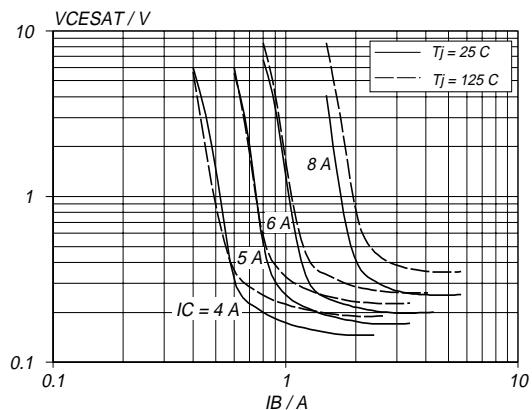


Fig.11. Typical collector-emitter saturation voltage.  $V_{CE\text{sat}} = f(I_B)$ ; parameter  $I_C$

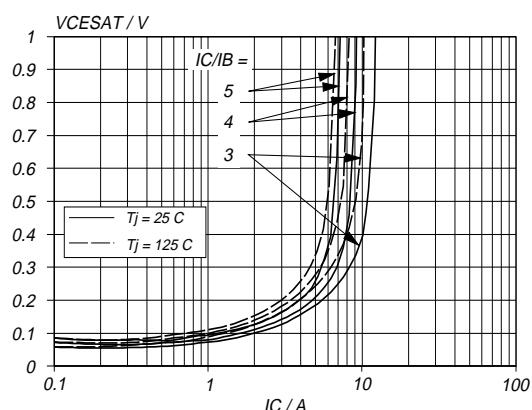


Fig.9. Typical collector-emitter saturation voltage.  $V_{CE\text{sat}} = f(I_C)$ ; parameter  $I_C/I_B$

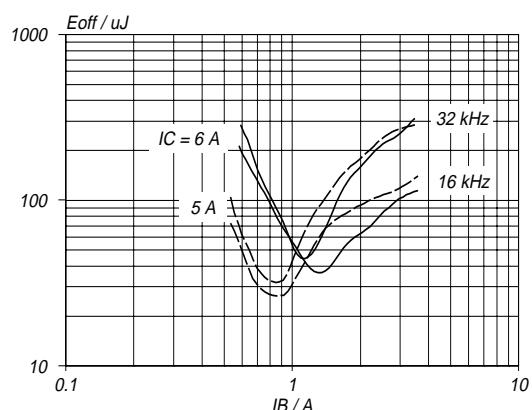


Fig.12. Typical turn-off losses.  $T_j = 85^{\circ}C$   
 $E_{off} = f(I_B)$ ; parameter  $I_C$ ; parameter frequency

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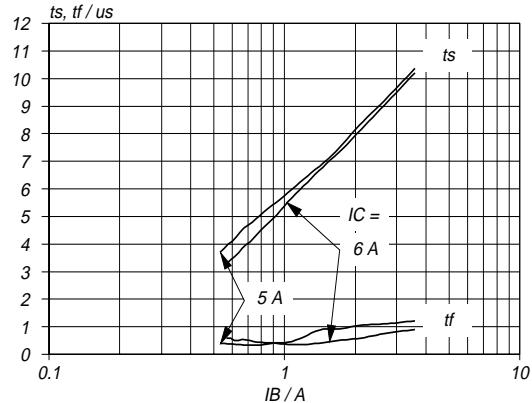


Fig.13. Typical collector storage and fall time.  
 $t_s = f(I_B)$ ;  $t_f = f(I_B)$ ; parameter  $I_C$ ;  $T_j = 85^\circ\text{C}$ ;  $f = 16 \text{ kHz}$

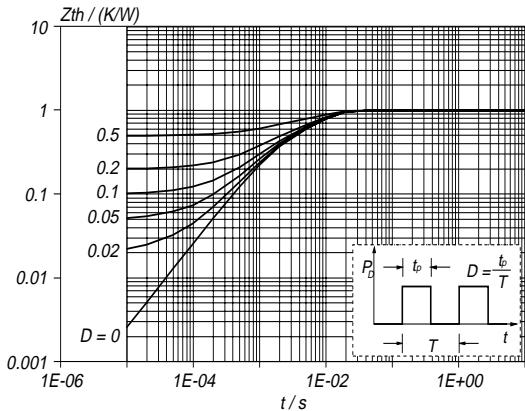


Fig.16. Transient thermal impedance.  
 $Z_{th,j-mb} = f(t)$ ; parameter  $D = t_p/T$

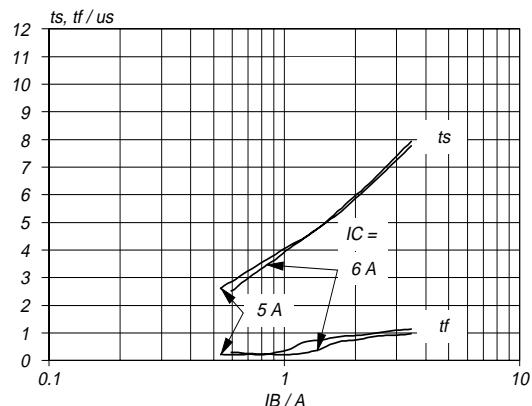


Fig.14. Typical collector storage and fall time.  
 $t_s = f(I_B)$ ;  $t_f = f(I_B)$ ; parameter  $I_C$ ;  $T_j = 85^\circ\text{C}$ ;  $f = 32 \text{ kHz}$

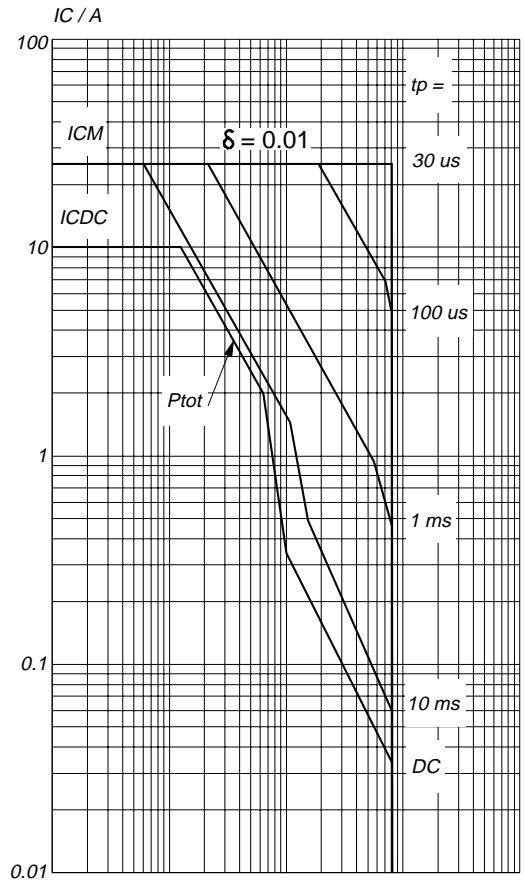


Fig.17. Forward bias safe operating area.  $T_{mb} = 25^\circ\text{C}$   
 $I_{CDC} \& I_{CM} = f(V_{CE})$ ;  $I_{CM}$  single pulse; parameter  $t_p$   
Second-breakdown limits independant of temperature.

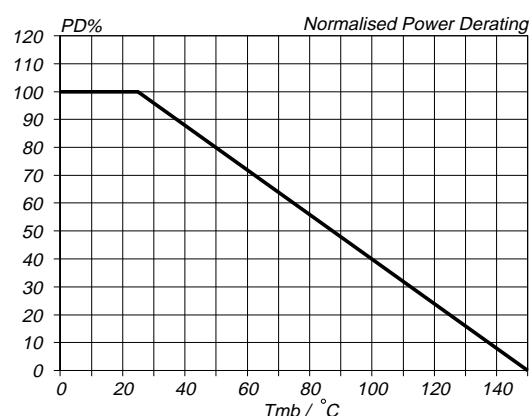


Fig.15. Normalised power dissipation.  
 $PD\% = 100 \cdot P_D / P_{D,25^\circ\text{C}} = f(T_{mb})$

**MECHANICAL DATA***Dimensions in mm*

Net Mass: 5 g

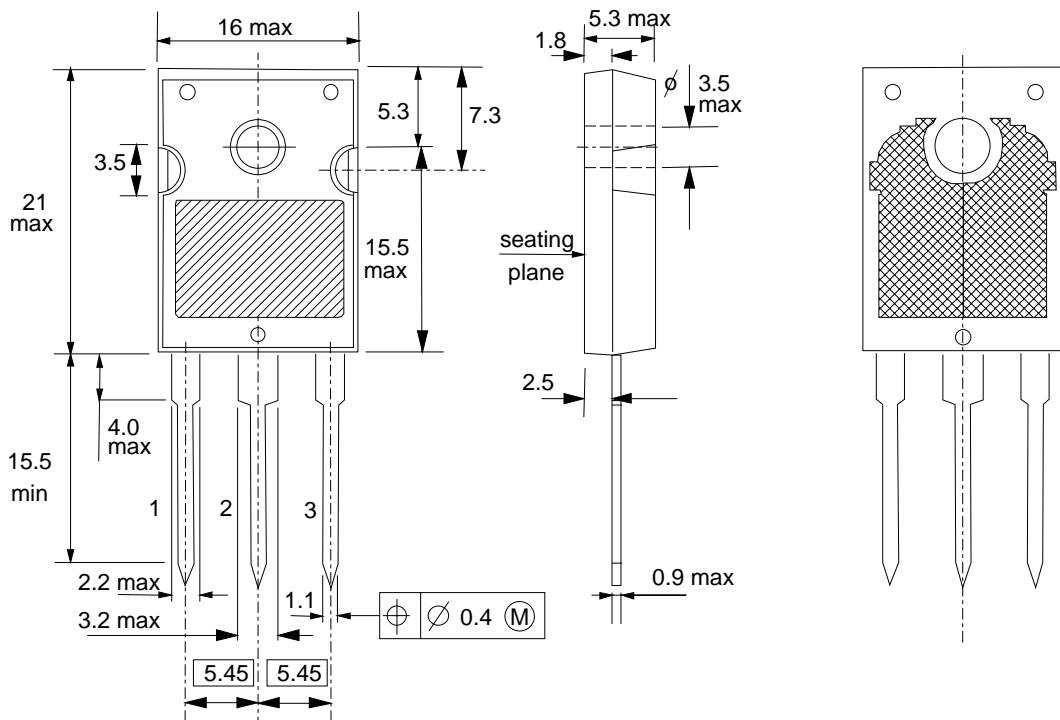


Fig.18. SOT429; pin 2 connected to mounting base.

**Notes**

1. Refer to mounting instructions for SOT429 envelope.
2. Epoxy meets UL94 V0 at 1/8".

**Silicon Diffused Power Transistor****BU2520AW****DEFINITIONS**

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	
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